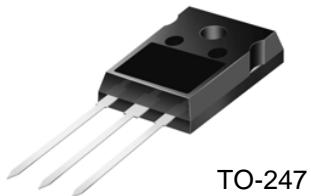


TSK60R070SFD

600V 47A N-Channel SJ-MOSFET

General Description

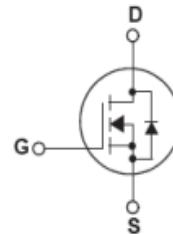
Truesemi SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.



TO-247

Features

- Fast-Recovery body diode
- Extremely Low Reverse Recovery Charge
- 650V @TJ = 150 °C
- Typ. RDS(on) = 60mΩ
- Ultra Low gate charge (typ. Qg = 170nC)
- 100% avalanche tested



Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	600	V
I _D	Drain Current -Continuous (TC = 25 °C) -Continuous (TC = 100 °C)	47* 29*	A
I _{DM}	Drain Current – Pulsed (Note 1)	140	A
V _{GSS}	Gate-Source voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	1135	mJ
I _{AR}	Avalanche Current (Note 1)	9.3	A
E _{AR}	Repetitive Avalanche Energy (Note 1)	1.72	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	40	V/ns
dvds/dt	Drain Source voltage slope (Vds=480V)	80	V/ns
P _D	Power Dissipation (TC = 25 °C)	391	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	°C

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Value	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case	0.32	°C/W
R _{θCS}	Thermal Resistance, Case-to-Sink Typ.	0.5	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62	°C/W

Electrical Characteristics TC = 25°C unless otherwise noted

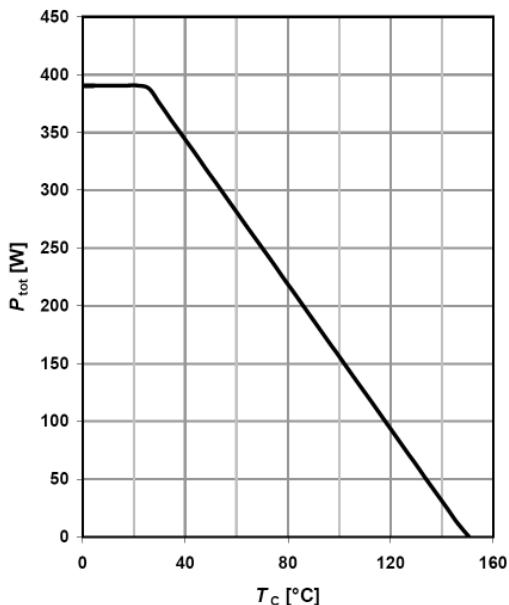
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA, T _J = 25°C	600	--	--	V
		V _{GS} = 0V, I _D = 250µA, T _J = 150°C	--	650	--	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250µA, Referenced to 25°C	--	0.6	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600V, V _{GS} = 0V T _C = 25°C -T _C = 150°C	--	--	1	µA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250µA	2.5	--	4.5	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 23A	--	60	70	mΩ
g _{FS}	Forward Trans conductance	V _{DS} = 40V, I _D = 25A	--	30	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	--	3100	--	pF
C _{oss}	Output Capacitance		--	610	--	pF
C _{rss}	Reverse Transfer Capacitance		--	15	--	pF
t _{d(on)}	Turn-On Delay Time	V _{DD} = 480V, I _D = 23A R _G = 20Ω (Note 4)	--	16	--	ns
t _r	Turn-On Rise Time		--	12	--	ns
t _{d(off)}	Turn-Off Delay Time		--	83	--	ns
t _f	Turn-Off Fall Time		--	5	--	ns
Q _g	Total Gate Charge	V _{DS} = 480V, I _D = 23A V _{GS} = 10V (Note 4)	--	170	--	nC
Q _{gs}	Gate-Source Charge		--	21	--	nC
Q _{gd}	Gate-Drain Charge		--	87	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current	--	--	47	A	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	140	A	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _F = 23A	--	0.9	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _F = 23A di _F /dt = 100A/µs	--	230	--	ns
Q _{rr}	Reverse Recovery Charge		--	3	--	µC
I _{rrm}	Peak Reverse Recovery Current		--	23	--	A

NOTES:

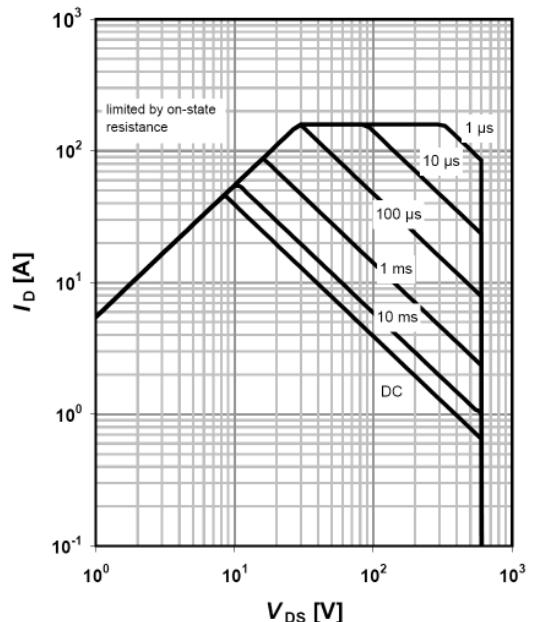
- Repetitive Rating: Pulse width limited by maximum junction temperature
- I_{AS}=9.3A, V_{DD}=50V, Starting T_J=25 °C
- I_{SD}≤23A, di/dt ≤ 200A/us, V_{DD}≤ BV_{DSS}, Starting T_J = 25 °C
- Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

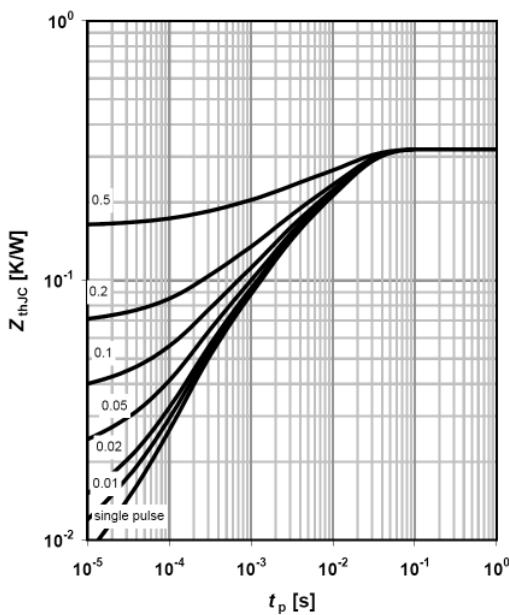
Power dissipation



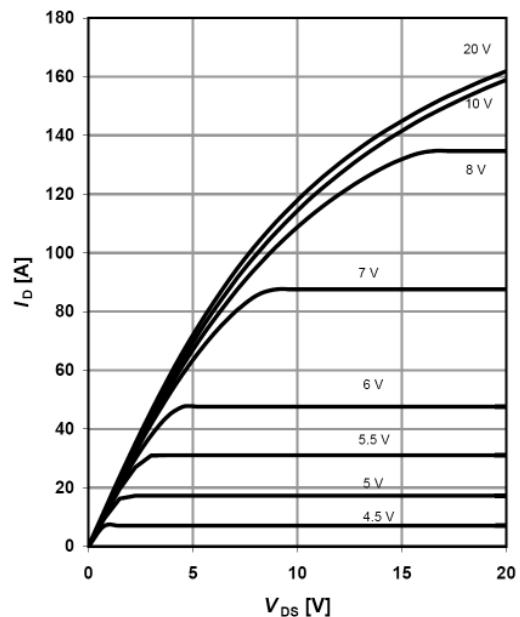
Safe operating area $T_C=25\text{ }^\circ\text{C}$



Max. transient thermal impedance

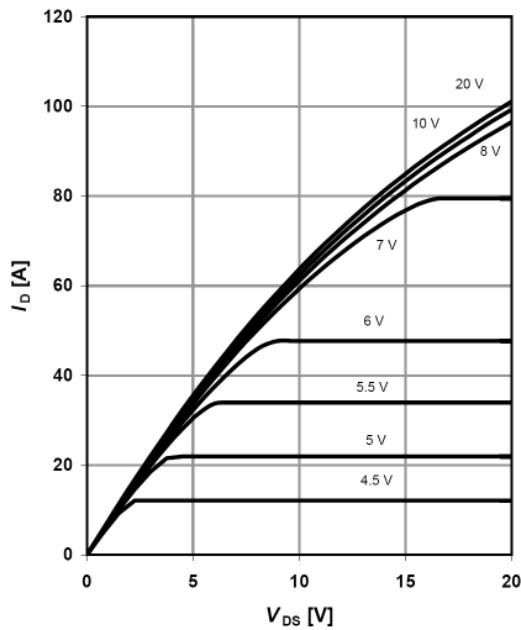


Typ. output characteristics $T_j=25\text{ }^\circ\text{C}$



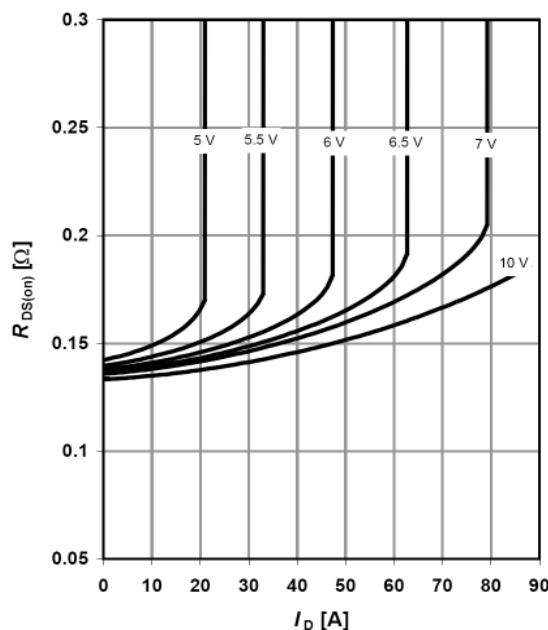
Typical Performance Characteristics

Typ. output characteristics $T_j=125\text{ }^\circ\text{C}$



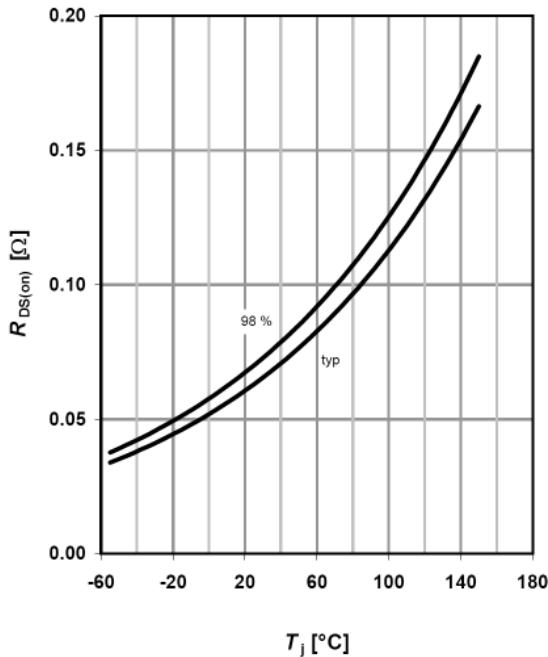
$I_D=f(V_{DS})$; $T_j=125\text{ }^\circ\text{C}$; parameter: V_{GS}

Typ. drain-source on-state resistance



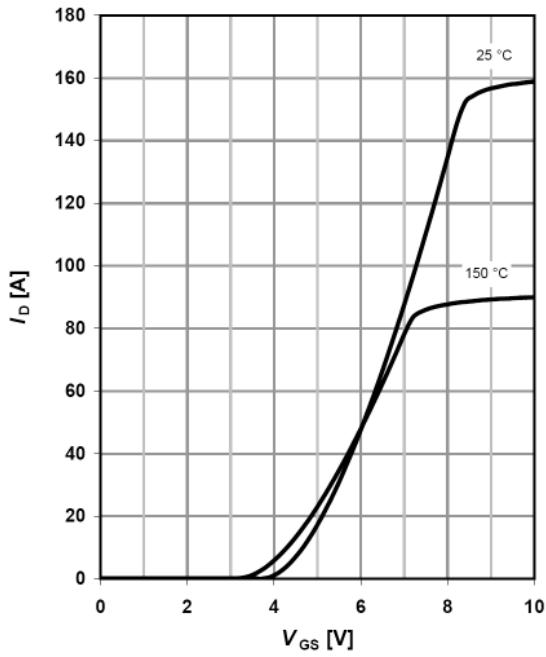
$R_{DS(on)}=f(I_D)$; $T_j=125\text{ }^\circ\text{C}$; parameter: V_{GS}

Typ. drain-source on-state resistance



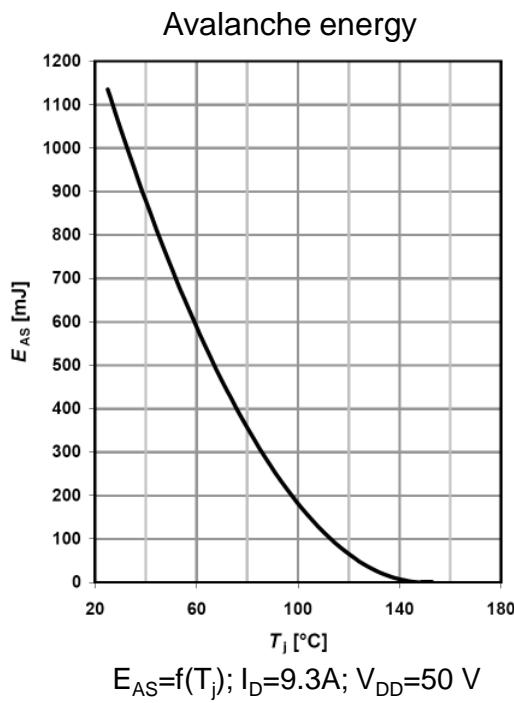
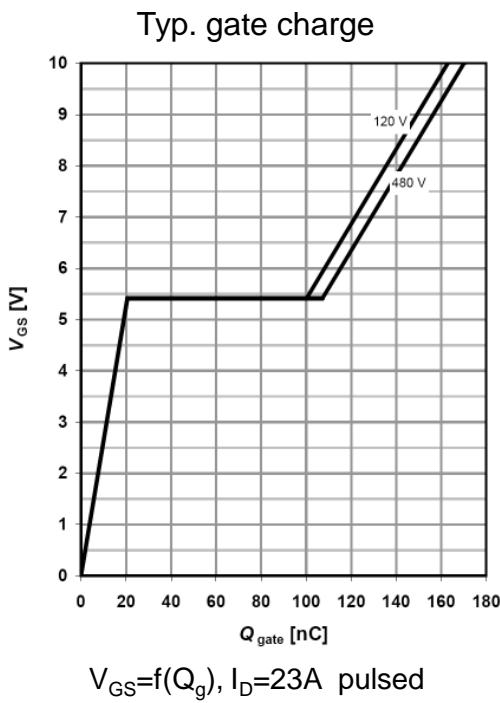
$R_{DS(on)}=f(T_j)$; $I_D=23\text{ A}$; $V_{GS}=10\text{ V}$

Typ. transfer characteristics

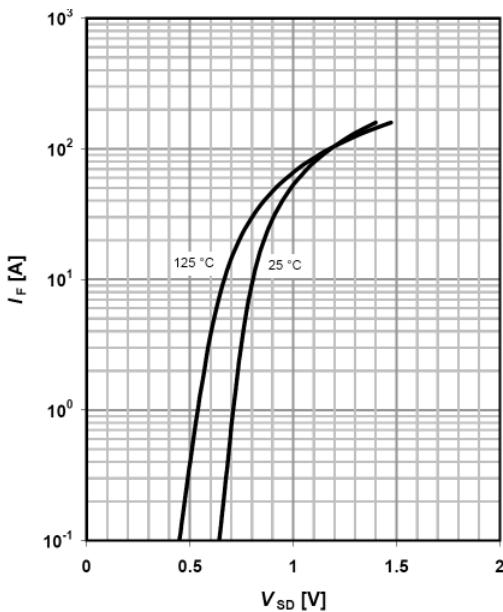


$I_D=f(V_{GS})$; $V_{DS}=40\text{ V}$

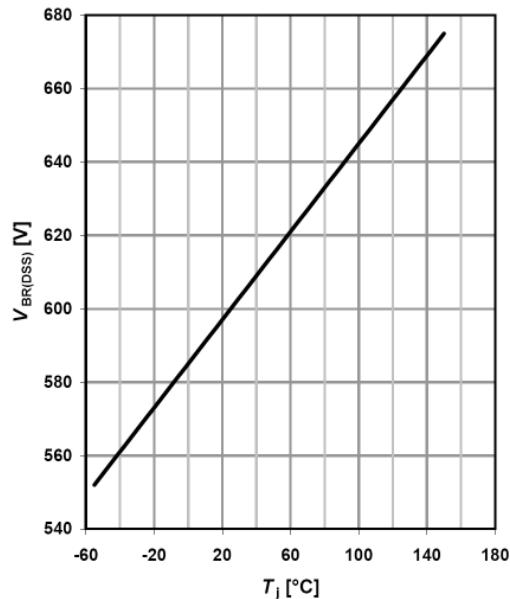
Typical Performance Characteristics



Forward characteristics of reverse diode

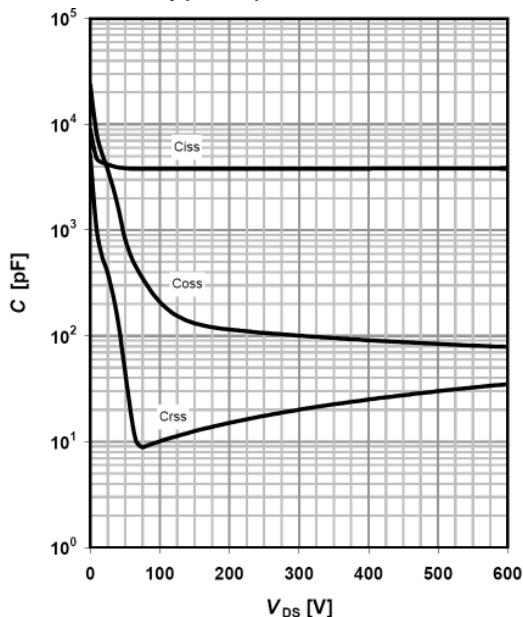


Drain-source breakdown voltage



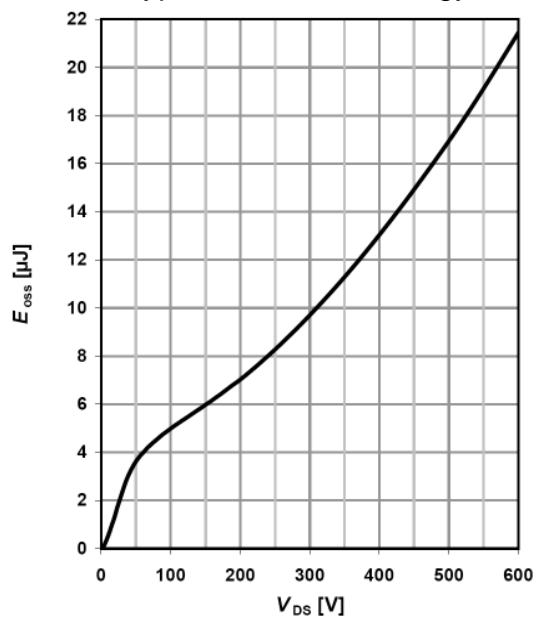
Typical Performance Characteristics

Typ. capacitances



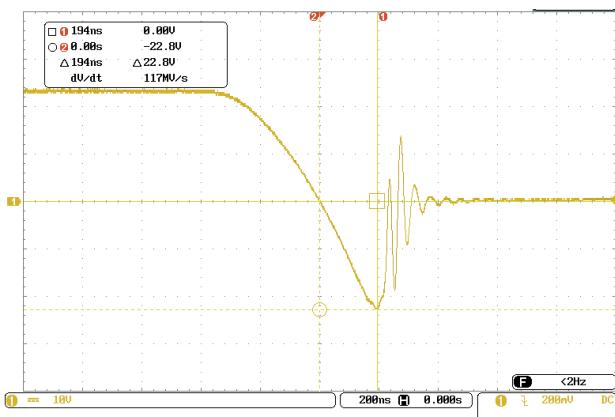
$C=f(V_{DS})$; $V_{GS}=0$ V; $f=1$ MHz

Typ. Coss stored energy



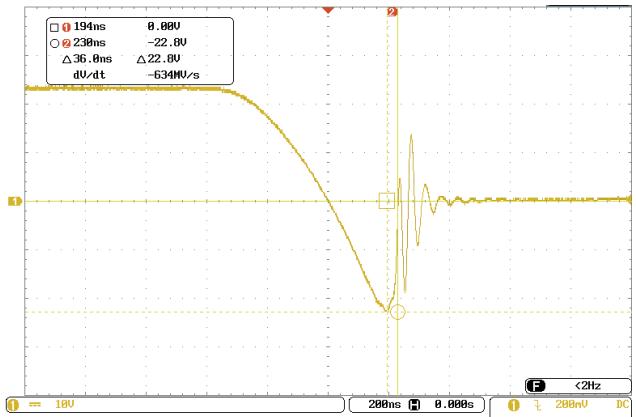
$E_{oss}=f(V_{DS})$

Typ. Recovery Time(T_s)



$VR=480V$, $I_s = 23A$, $dI/dt = 100A/\mu s$

Typ. Recovery Time(T_f)

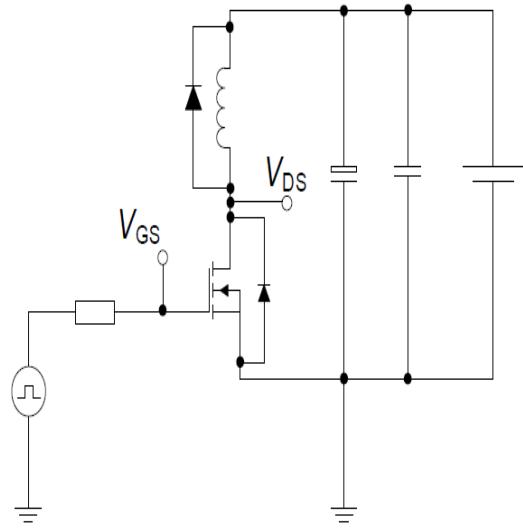


$VR=480V$, $I_s = 23A$, $dI/dt = 100A/\mu s$

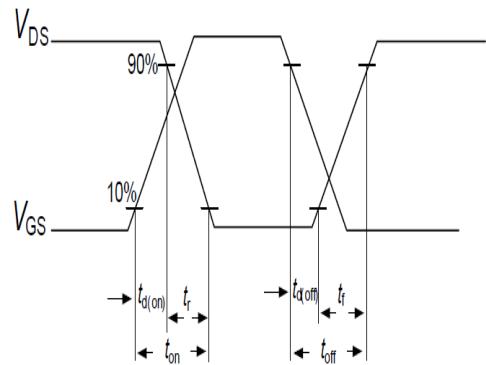
Test circuits

Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

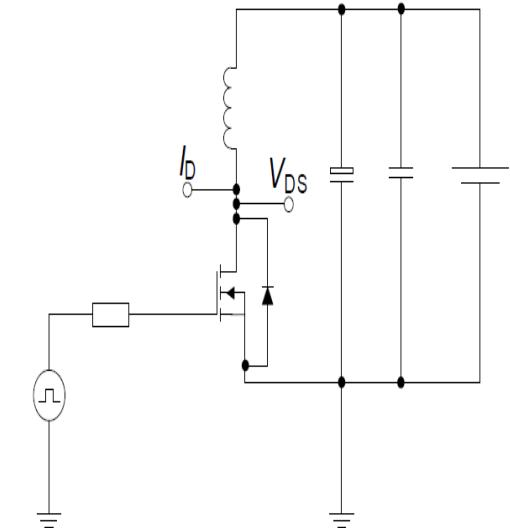


Switching time waveform

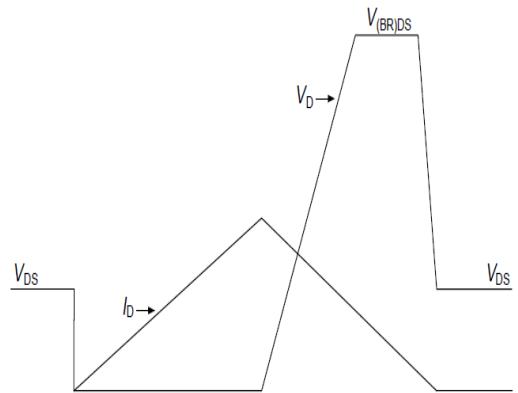


Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit

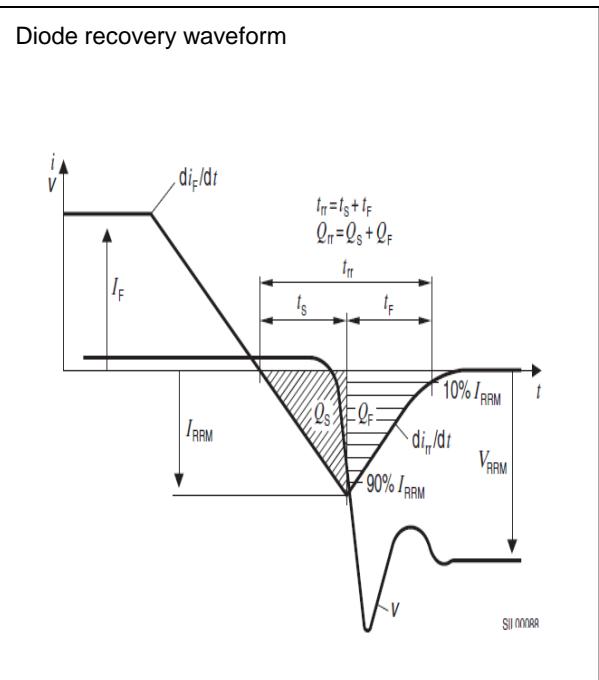
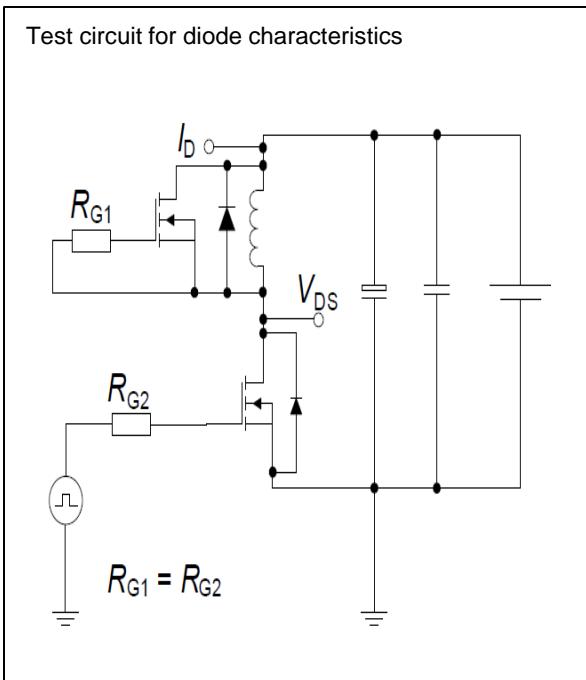


Unclamped inductive waveform



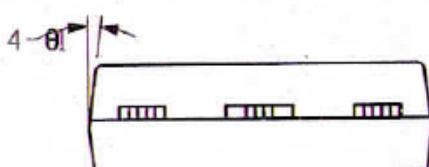
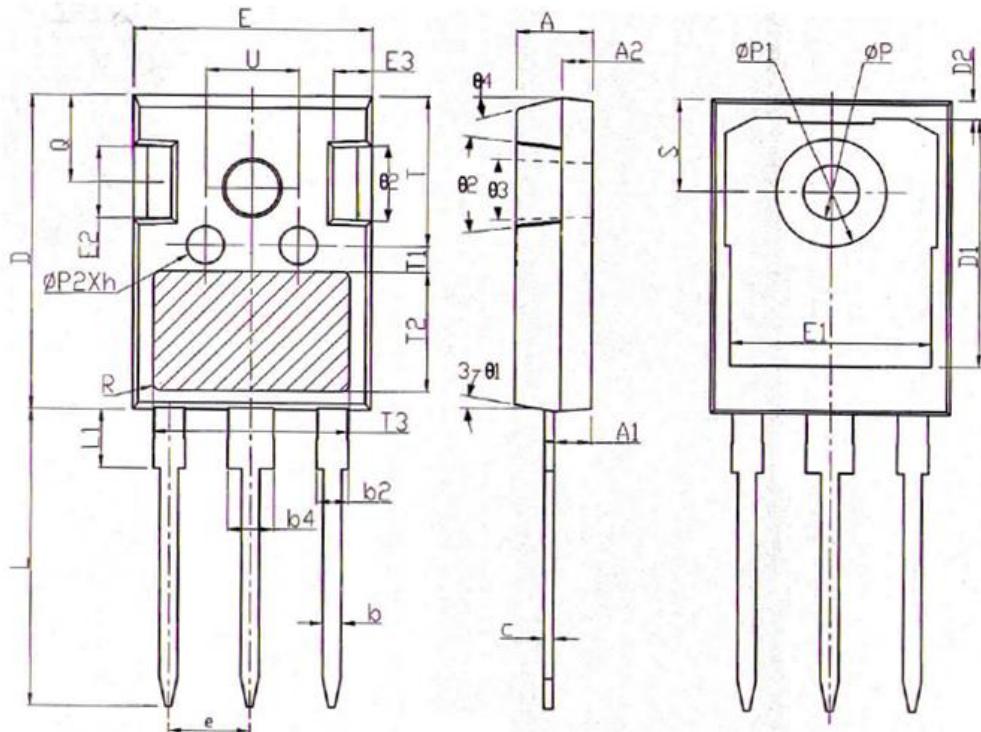
Test circuits

Test circuit and waveform for diode characteristics



Package Outline TO-247

TSK60R070SFD 600V 47A N-Channel SJ-MOSFET



COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16	1.21	1.26
b2	1.96	2.01	2.06
b4	2.96	3.01	3.06
c	0.59	0.61	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.44BSC		
h	0.05	0.10	0.15
L	19.80	19.92	20.10
L1	-	-	4.30
ΦP	3.50	3.60	3.70
ΦP1	-	-	7.30
ΦP2	2.40	2.50	2.60
Q	5.60	5.80	6.00
S	6.15BSC		
R	0.50REF		
T	9.80	-	10.20
T1	1.65REF		
T2	8.00REF		
T3	12.80REF		
U	6.00	-	6.40
θ1	6°	7°	8°
θ2	4°	5°	6°
θ3	1°	-	1.5°
θ4	14°	15°	16°